

STPS2H100-Y

Automotive power Schottky rectifier

Features

- Negligible switching losses
- High junction temperature capability
- Low leakage current
- Good trade-off between leakage current and forward voltage drop
- Avalanche capability specified
- ECOPACK[®]2 compliant component
- AEC-Q101 qualified

Description

Schottky rectifiers designed for high frequency miniature switched mode power supplies such as adaptators and on board DC/DC converters. Available in SMA and SMB.





Table 1.Device summary

Symbol	Value
I _{F(AV)}	2 A
V _{RRM}	100 V
T _j (max)	175 °C
V _F (max)	0.65 V

1 Characteristics

Table 2. Absolute ratings (limiting values)

Symbol	Pa	Value	Unit		
V _{RRM}	Repetitive peak reverse voltage			100	V
I _{F(AV)}	Average forward current SMA / SMB		$T_{L} = 130 \ ^{\circ}C \ \delta = 0.5$	2	А
I _{FSM}	Surge non repetitive forward cu	t _p =10 ms sinusoidal	75	А	
P _{ARM}	Repetitive peak avalanche power $t_p = 1 \ \mu s \ T_j = 25 \ ^{\circ}C$			2400	W
T _{stg}	Storage temperature range	-65 to +175	°C		
Тj	Operating junction temperature range ⁽¹⁾ -40 to +175				

1. $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter Value			Unit
Р	Junction to lead	SMA	30	°C/W
R _{th(j-l)}	Junction to lead	SMB	25	C/VV

Table 4. Static electrical characteristics

Symbol	Parameter	Test co	Min.	Тур.	Max.	Unit	
L (1)	I _R ⁽¹⁾ Reverse leakage current	T _j = 25 °C	V _R = V _{RRM}	-	-	1	μA
'R'		T _j = 125 °C		-	0.4	1	mA
		T _j = 25 °C	I _F = 2 A I _F = 4 A	-	-	0.79	
V _F ⁽²⁾	Forward voltage drop	T _j = 125 °C		-	0.6	0.65	V
ve, , , ,	Tolward voltage drop	T _j = 25 °C		-	-	0.88	v
		T _j = 125 °C		-	0.69	0.74	

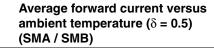
1. Pulse test: $t_p = 5 \text{ ms}, \delta < 2\%$

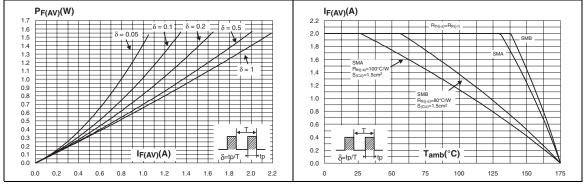
2. Pulse test: t_p = 380 µs, δ < 2%

To evaluate the conduction losses use the following equation: P = 0.56 x $I_{F(AV)}$ + 0.045 ${I_F}^2_{(RMS)}$



Figure 1. Average forward power dissipation Figure 2. versus average forward current





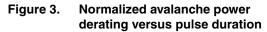


Figure 4. Normalized avalanche power derating versus junction temperature

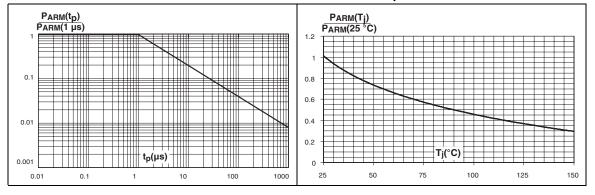
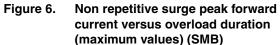
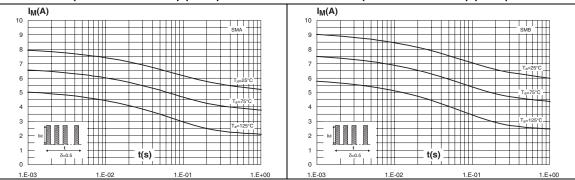


Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values) (SMA)





57

0.2

0.1

0.0

1.E-02

1.E-01

100

80

Figure 7. **Relative variation of thermal** Figure 8. Reverse leakage current versus impedance junction to ambient reverse voltage applied versus pulse duration (SMA / SMB) (typical values) 1.E+04 Ι<mark>R(μΑ)</mark> Zth(j-a)/Rth(j-a) 1.0 ++++++ 0.9 1.E+03 T_j=150°C 0.8 T_i=125°C 0.7 1.E+02 0.6 1.E+01 0.5 T,=75°C 0.4 T.=50°C 1.E+00 0.3

"i I II

1.E+03

Figure 9. Junction capacitance versus reverse voltage applied

1.E+00

t_p(s)

1.E+01

_δ≓

1.E+02

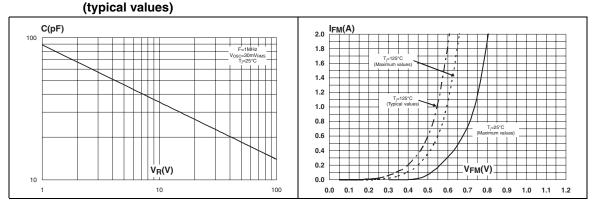
Figure 10. Forward voltage drop versus forward current (low level)

40

T_j=25°0

V_R(V)

60



1.E-01

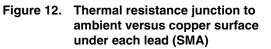
1.E-02

0

20



Figure 11. Forward voltage drop versus forward current (high level)



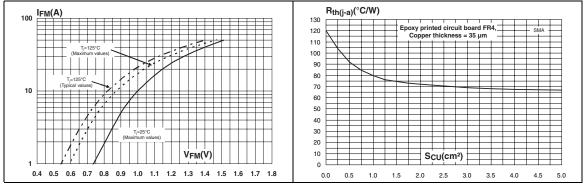
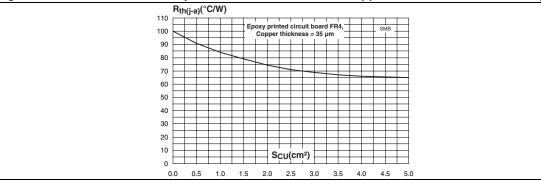


Figure 13. Thermal resistance junction to ambient versus copper surface under each lead (SMB)





2 Package information

- Epoxy meets UL94, V0
- Lead-free packages

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK[®] is an ST trademark.

Table 5. SMA dimensions

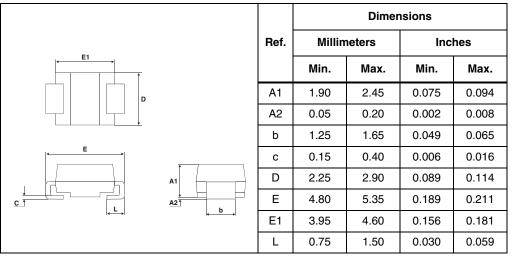


Figure 14. SMA footprint (dimensions in mm)

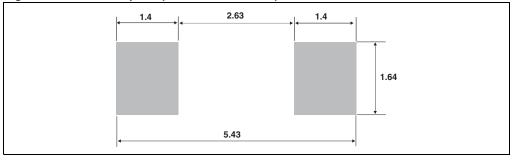
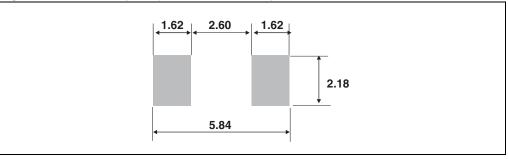




Table 6.	SIMB dimensio	lis					
				Dimensions			
	E1		Ref.	Millimeters		Inches	
-				Min.	Max.	Min.	Max.
			A1	1.90	2.45	0.075	0.096
			A2	0.05	0.20	0.002	0.008
	b	1.95	2.20	0.077	0.087		
	С	0.15	0.40	0.006	0.016		
	A1	Е	5.10	5.60	0.201	0.220	
		E1	4.05	4.60	0.159	0.181	
		l ∢ ▶	D	3.30	3.95	0.130	0.156
l			L	0.75	1.50	0.030	0.059

Table 6.SMB dimensions

Figure 15. SMB footprint (dimensions in mm)





3 Ordering information

Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS2H100AY	S21Y	SMA	0.068 g	5000	Tape and reel
STPS2H100UY	G21Y	SMB	0.107 g	2500	Tape and reel

4 Revision history

Table 8.Document revision history

Date	Revision	Changes
03-Dec-2010	1	Initial release.



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